APRIL 1985-REVISED MARCH 1988

- Two-Way Asynchronous Communication Between Data Buses
- PNP Inputs Reduce D-C Loading
- Hysteresis (Typically 400 mV) at Inputs Improves Noise Margin

### description

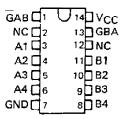
These four-data-line transceivers are designed for asynchronous two-way communications between data buses. The SN74LS' can be used to drive terminated lines down to 133 ohms.

The SN54′ family is characterized for operation over the full military temperature range of  $-55^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . The SN74′ family is characterized for operation from  $0^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ .

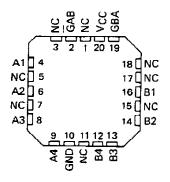
### **FUNCTION TABLE (EACH TRANSCEIVER)**

INPUTS		'LS242	'LS243			
GAB	GBA	LS242	L5243			
L	L	A to B	A to B			
Н	Н	B to A	B to A			
Н	L	Isolation	Isolation			
		Latch A and B	Latch A and B			
L	Н	(A = B)	(A = B)			

SN54LS242, SN54LS243 . . . J OR W PACKAGE SN74LS242, SN74LS243 . . . D OR N PACKAGE (TOP VIEW)

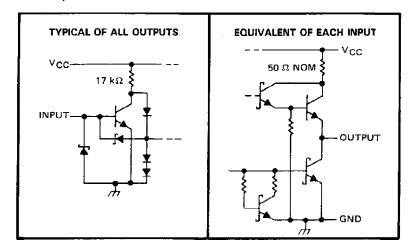


SN54LS242, SN54LS243 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

### schematics of inputs and outputs



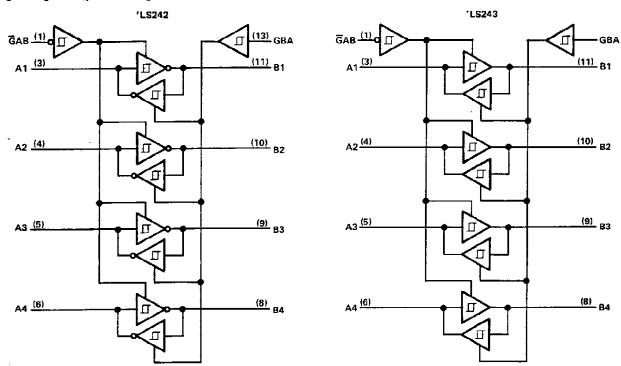
PRODUCTION DATA documents contain information current as of publication data. Products conform to specifications per the terms of Taxas instruments standard warranty. Production processing does not necessarily include testing of all parameters.



## SN54LS242, SN54LS243, SN74LS242, SN74LS243 QUADRUPLE BUS TRANSCEIVERS

#### logic symbols† 'L\$243 'LS242 (13) GBA GBA ☐ EN1 ∐ EN1 GAB (1) GAB **□ EN2 ∐ EN2** П $\triangleright$ 2 ▽ (10) ₽2 В2 (9) (9) В3 ВЗ (8) B4 A4 (6)

## logic diagrams (positive logic)



Pin numbers shown are for D, J, N, and W packages.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

- 11 / 27 00		
		5.5 V
Off-state output voitage	. , , ,	J.J.V
Operating free-air temperature range:	SN54LS'	– 55°C to 125°C
· -	SN74LS'	
Storage temperature range		– 65°C to 150°C
NOTE 1: Voitage values are with respect to netw		

<sup>†</sup>These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

## recommended operating conditions

		SN54LS'			SN74LS'		
	MIN	MOM	MAX	MIN	NOM	MAX	UNIT
V <sub>CC</sub> Supply voltage, (see Note 1)	4.5	5	5.5	4.75	5	5.25	٧
V <sub>1H</sub> High-level input voltage	2			2	· ·		V
VIL Low-level input voltage			0.7			8.0	٧
IOH High-level output current			<b>- 12</b>	1		<b>– 15</b>	mA
IOL Low-level output current			12			24	mΑ
TA Operating free-air temperature	<i>–</i> 55		125	0	··· <u>-</u>	70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		TEST SOURTIONS!		SN54LS'			SN74LS'			UNIT	
P/	ARAMETER	TEST CONDITIONS†			MIN	MIN TYP\$ MAX MIN T		TYP‡	MAX	ONIT	
Vik	A or B	V <sub>CC</sub> = MIN.	I <sub>I</sub> = - 18 mA				<b>— 1.5</b>		•	<b>— 1.5</b>	_ v _
	esis (V <sub>T+</sub> – V <sub>T</sub> )	V <sub>CC</sub> = MIN			0.2	0.4		0.2	0.4		V
Vон		V <sub>CC</sub> = MIN, I <sub>OH</sub> = - 3 mA	V <sub>IH</sub> - 2 V,	V <sub>IL</sub> = MAX,	2.4	3.1		2.4	3.1		,
		V <sub>CC</sub> = MIN, IOH = MAX	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.5 V,	2			2			
	<u></u> ,	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>QL</sub> = 12 mA		0.25	0.4		0.25	0.4	V
VOL		VIL = MAX		IOL = 24 mA					0.35	0.5	
lozн	· —	V <sub>CC</sub> = MAX,	V <sub>IH</sub> = 2 V,	V <sub>O</sub> = 2.7 V			40			40	μА
IOZL		VIL = MAX		V <sub>O</sub> = 0.4 V			- 200			- 200	μΑ
	A or B	1/ 1443/	<del></del>	V <sub>1</sub> = 5.5 V			0.1	0.		0.1	mA
iı	GAB or GBA	VCC = MAX,		V <sub>1</sub> = 7 V			0.1			0.1	****
ΉΗ		VCC = MAX.	V <sub>1</sub> = 2.7 V				20			20	μА
	A inputs	T -	$V_{CC} = MAX$ , $V_{\parallel} = 0.4 V$ , GAB and GBA at 0 V				- 0.2			- 0.2	
lir.	B inputs	V <sub>CC</sub> ≈ MAX. GAB and GBA a					- 0.2			- 0.2	mA
	GAB or GBA	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				- 0.2			- 0.2	
losε	<u> </u>	V <sub>CC</sub> = MAX	· .		40		- 225	- 40		- 225	mΑ
	Outputs high		= MAX, Outputs open, lote 2	'LS242, 'LS243		22	38		22	38	
	Outputs low	V <sub>CC</sub> = MAX,		'L5242, 'L5243		29	50		29	50	mΑ
ICC	All outputs	See Note 2		'LS242		29	50		29	50	,
	disabled			'L\$243		32	54		32	54	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

	_	'L\$242			'LS243				
PARAMETER	TEST CONDITIONS			TYP	MAX	MIN	TYP	MAX	UNIT
tpLH		<u> </u>		9	14		12	18	กร
TPHL	R <sub>1.</sub> = 667 Ω	$C_L = 45 pF$ ,		12	18		12	18	п\$
tPZL	See Nate 3			20	30		20	30	ns
tPZH				15	23		15	23	ns
†PLZ	R <sub>L</sub> = 667 Ω,	C <sub>L</sub> = 5 pF,		10	20		10	20	ns
lPHZ	See Note 3	_		15	25		15	25	пş

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.



<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured with transceivers anabled in one direction only, or with all transceivers disabled.

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